3.3 V parallel interface transceiver/buffer

Rev. 03 — 25 August 2008

**Product data sheet** 

#### 1. General description

The PDI1284P11 parallel interface chip is designed to provide an asynchronous, 8-bit, bidirectional, parallel interface for personal computers. The PDI1284P11 includes all 19 signal lines defined by the IEEE 1284 interface specification for Byte, Nibble, EPP, and ECP modes. The PDI1284P11 is designed for hosts or peripherals operating at 3.3 V to interface 3.3 V or 5.0 V devices.

The eight transceiver pairs (A/B 1 to 8) allow data transmission from the A-bus to the B-bus, or from the B-bus to the A-bus, depending on the state of the direction pin DIR.

The B-bus and the Y9 to Y13 lines have either totem pole or resistor pull-up outputs, depending on the state of the high drive enable pin HD. The A-bus has only totem pole style outputs. All inputs are TTL compatible with at least 400 mV of input hysteresis at  $V_{CC} = 3.3$  V.

#### 2. Features

- Asynchronous operation
- 8-bit transceivers
- Six additional buffer/driver lines peripheral to cable
- Five additional control lines from cable
- 5 V tolerant
- ESD protection:
  - HBM JESD22-A114E exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Latch-up current protection exceeds 500 mA per JEDEC Std 19
- Input hysteresis
- Low-noise operation
- IEEE 1284 compliant level 1 and 2
- Overvoltage protection on B/Y side for off-state
- A side 3-state option
- B side active or resistive pull-up option
- Cable side supply voltage for 5 V or 3 V operation

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### 3. Ordering information

Type number	Package						
	Temperature range	Name	Description	Version			
PDI1284P11DL	0 °C to 70 °C	SSOP48	plastic shrink small outline package; 48 leads; body width 7.5 mm	SOT370-1			
PDI1284P11DGG	0 °C to 70 °C	TSSOP48	plastic thin shrink small outline package; 48 leads; body width 6.1 mm	SOT362-1			

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### 4. Functional diagram



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### 5. Pinning information

#### 5.1 Pinning



#### 5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
HD	1	high drive enable/disable input
A1 to A8	8, 9, 11, 12, 13, 14, 16, 17	data input/output
B1 to B8	41, 40, 38, 37, 36, 35, 33, 32	IEEE 1284 standard output/input <sup>[1]</sup>
A9 to A13	2, 3, 4, 5, 6	data input
Y9 to Y13	47, 46, 45, 44, 43	IEEE 1284 standard output <sup>[1]</sup>
C14 to C17	29, 28, 27, 26	control input (cable) <sup>[1]</sup>
A14 to A17	20, 21, 22, 23	control output (peripheral)
V <sub>CC</sub>	7, 18	supply voltage
GND	10, 15, 39	ground (0 V)
PLHI	19	peripheral logic high input (peripheral)

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Table 2.	Pin descripti	Pin descriptioncontinued		
Symbol	Pin	Description		
HLHO	24	host logic high output (cable)		
HLHI	25	host logic high input (cable)		
PLHO	30	peripheral logic high output (cable)		
V <sub>CC(B)</sub>	31, 42	supply voltage B (cable side 3 V/5 V)		
OEA	34	A side output enable input (active LOW)		
DIR	48	direction selection input		

[1] Pin with pull-up resistor to load cable.

### 6. Functional description

#### Function table<sup>[1]</sup> Table 3. DIR **OEA** HD Output Input Output type C14 to C17 A14 to A17 Х Х Х TP Х Х Х HLHI HLHO TP Х Х L A9 to A13 Y9 to Y13 RP Х Х Н A9 to A13 Y9 to Y13 TΡ Х Х L PLHI PLHO OC Х Х н PLHI PLHO TΡ Х L A1 to A8 B1 to B8 Н RP Х Н A1 to A8 B1 to B8 TΡ Н A1 to A8 L L Х TΡ B1 to B8 L Н Х A1 to A8 Z<mark>[2]</mark> -Х B1 to B8 **RP**<sup>[2]</sup> L н -

#### 6.1 Function selection

[1] An = side driving internal IC;

Bn = side driving external cable (bidirectional);

Cn = side receiving control signals from external cable;

H = HIGH voltage level;

L = LOW voltage level;

OC = Open Collector;

X = don't care (control signals in);

Yn = side driving external cable (unidirectional);

Z = high impedance (high-Z) or 3-state;

TP = totem pole output;

RP = resistive pull-up: 1.4 k $\Omega$  (nominal) on B/Y/C cable side and V<sub>CC</sub>. However, while a B/Y side output is LOW as driven by a LOW signal on the A side, that particular B/Y side resistor is switched off to stop current drain from V<sub>CC</sub> through it.

[2] When DIR = L and  $\overline{OEA}$  = H, the output signal is isolated from the input signal. Signals B1 to B8 maintain a resistive pull-up of 1.4 k $\Omega$  on the input for this mode.

#### 7. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).[1]

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage	pins V <sub>CC</sub>	-0.5	+4.6	V
V <sub>CC(B)</sub>	supply voltage B	pins $V_{CC(B)}$ ; cable side 3 V/5 V	-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-	±20	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-	±50	mA
VI	input voltage		[2] -0.5	+5.5	V
Vo	output voltage	B/Y side	[2] -0.5	+5.5	V
		A side	-0.5	V <sub>CC</sub> + 0.5	V
V <sub>trt</sub>	transient voltage	B/Y side; 40 ns transient	<u>[3]</u> –2	+7	V
I <sub>CC</sub>	supply current		-	200	mA
I <sub>GND</sub>	ground current		-200	-	mA
lo	output current	output HIGH or LOW	-	±50	mA
T <sub>stg</sub>	storage temperature		-60	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = 0 \ ^{\circ}C \ to \ +70 \ ^{\circ}C$	<u>[4]</u> _	500	mW

[1] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

[2] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[3] V<sub>trt</sub> guarantees only that the PDI1284P11 will not be damaged by reflections in application so long as the voltage levels remain in the specified range.

[4] Above 60  $^\circ\text{C}$  the value of P\_tot derates linearly with 5.5 mW/K.

### 8. Recommended operating conditions

#### Table 5.Operating conditions

V <sub>CC</sub>	supply voltage	pins V <sub>CC</sub>			
			3.0	3.6	V
V <sub>CC(B)</sub>	supply voltage B	pins $V_{CC(B)}$ ; cable side 3 V/5 V	3.0	5.5	V
V <sub>IH</sub>	HIGH-level input voltage		2.0	-	V
V <sub>IL</sub>	LOW-level input voltage		-	0.8	V
Vo	output voltage	pins Bn, Yn	-0.5	+5.5	V
		pins An	0	V <sub>CC</sub>	V
I <sub>OH</sub>	HIGH-level output current	pins Bn, Yn	-	-14	mA
I <sub>OL</sub>	LOW-level output current	pins Bn, Yn	-	14	mA
T <sub>amb</sub>	ambient temperature	free-air	0	70	°C

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#### 9. Static characteristics

#### Table 6.Static characteristics

 $T_{amb} = 0 \circ C$  to  $70 \circ C$ ; ground = 0 V; unless specified otherwise.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>IL</sub>	LOW-level input	An, Bn, Cn and PLHI inputs; $V_{CC}$ = 3.0 V to 3.6 V		-	-	0.8	V
	voltage	HLHI input; $V_{CC}$ = 3.0 V		-	-	1.55	V
VIH	HIGH-level input	An, Bn, PLHI inputs; $V_{CC}$ = 3.0 V to 3.6 V		2.0	-	-	V
	voltage	Cn inputs; $V_{CC}$ = 3.0 V to 3.6 V		2.3	-	-	V
		HLHI input; $V_{CC}$ = 3.6 V		2.6	-	-	V
V <sub>H</sub>	hysteresis	An, Bn inputs; V_{CC} = 3.3 V; V_{IL} = 0.8 V; V_{IH} = 2.0 V	[1]	0.4	0.47	-	V
	voltage	Cn inputs; $V_{CC} = 3.3 V$	[1]	0.8	0.47	-	V
V <sub>OL</sub>	LOW-level	pins An, HLHO; I <sub>OL</sub> = 50 $\mu$ A; V <sub>CC</sub> = 3.0 V		-	-	0.2	V
	output voltage	pins An, HLHO; $I_{OL}$ = 4 mA; $V_{CC}$ = 3.0 V		-	-	0.4	V
		pins Bn, Yn; $I_{OL}$ = 14 mA; $V_{CC}$ = 3.0 V		-	-	0.77	V
		pin PLHO; $I_{OL} = 500 \ \mu\text{A}$ ; $V_{CC} = 3.0 \ V$		-	-	0.8	V
V <sub>OH</sub>	HIGH-level	pins An, HLHO; I <sub>OH</sub> = $-500 \ \mu\text{A}$ ; V <sub>CC</sub> = 3.0 V		2.8	-	-	V
	output voltage	pins An, HLHO; $I_{OH} = -4$ mA; $V_{CC} = 3.0$ V		2.4	-	-	V
		pins Bn, Yn; $I_{OH}$ = -14 mA; $V_{CC}$ = 3.0 V		2.23	-	-	V
		pin PLHO; $I_{OH}$ = 500 $\mu$ A; $V_{CC}$ = 3.15 V		3.1	-	-	V
I <sub>CC</sub>	supply current	$V_I = 0 \text{ V or } V_{CC}; I_O = 0 \text{ A}$	[1]	-	5	-	μA
		pins V <sub>CC</sub> and V <sub>CC(B)</sub> ; V <sub>CC</sub> = 3.6 V; V <sub>CC(B)</sub> = 3.6 V to 5.5 V; V <sub>I</sub> = 0 V or V <sub>CC</sub> ; pins Bn = V <sub>CC(B)</sub> ; pins Cn = V <sub>CC(B)</sub> or floating		-	0.1	100	μΑ
	pins $V_{CC(B)}$ ; $V_{CC} = 3.6 \text{ V}$ ; $V_I = 0 \text{ V} \text{ or } V_{CC}$ ; pins $Cn = 0 \text{ V}$	[2]					
	pin DIR = 3.6 V; V <sub>CC(B)</sub> = 3.6 V		-	10	15	mA	
	pin DIR = 3.6 V; $V_{CC(B)}$ = 5.5 V		-	16	20	mA	
		pin DIR = 0 V; $V_{CC(B)}$ = 3.6 V; pins Bn = 0 V		-	30	40	mA
		pin DIR = 0 V; $V_{CC(B)}$ = 5.5 V; pins Bn = 0 V		-	47	60	mA
OFF	power-off	pins Bn, Cn, Yn; $V_0$ = 5.5 V; $V_{CC}$ = 0 V					
	leakage current	$V_{CC(B)} = 0 V$		-	-	±100	μA
		$V_{CC(B)} = 4.5 V$		-	-	±100	μA
lı	input leakage current	$V_I = 0 V \text{ to } V_{CC}$	<u>[3]</u>	-	-	±1	μA
oz	OFF-state output current	3-state; $V_0 = V_{CC}$ or 0 V	<u>[3]</u>	-	-	±20	μA
Ro	output	V <sub>CC</sub> = 3.3 V; see <u>Figure 9</u>					
	resistance	$V_{O}$ = 1.65 V $\pm$ 0.1 V; B/Y side	[1]	35	45	55	Ω
R <sub>PU</sub>	pull-up resistance	B/Y side; $V_{CC}$ = 3.3 V; output in high-Z with resistive pull-up	[1]	1.15	1.4	1.65	kΩ

[1] Typical values at  $T_{amb} = 25 \ ^{\circ}C$ .

[2] Includes extra  $I_{CC(B)}$  current from pull-up resistors, i.e.  $I_{CC(B)}$  = (total number of LOW inputs on B and C sides) × ( $V_{CC(B)} / R_{PU}$ ).

[3] The pull-up resistor on the B side outputs makes it impossible to test I<sub>OZ</sub> on the B side. This applies to the input current on the C side inputs as well.

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#### **10.** Dynamic characteristics

#### Table 7. Dynamic characteristics

 $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ ; ground = 0 V;  $C_L = 50 \text{ pF}$ ;  $R_L = 500 \Omega$ ;  $T_{amb} = 0 \circ C$  to 70  $\circ C$ ; unless specified otherwise.

Symbol	Parameter	Conditions	Min	Typ <mark>[2]</mark>	Max	Unit
t <sub>PLH</sub>	LOW to HIGH propagation delay	An to Bn or Yn; see Figure 3 and 8	0	12.5	20	ns
t <sub>PHL</sub>	HIGH to LOW propagation delay	An to Bn or Yn; see Figure 3 and 8	0	13.9	23	ns
t <sub>pd</sub>	propagation delay	see Figure 4 and 8	<u>[1]</u>			
		Bn to An	0	-	12	ns
		Cn to An	-	-	15	ns
		PLHI to PLHO	-	-	20	ns
		HLHI to HLHO	-	-	15	ns
SR	slew rate	Bn/Yn; R <sub>L</sub> = 62 $\Omega$ ; see <u>Figure 5</u> and <u>8</u>	0.05	0.2	0.4	V/ns
t <sub>dis</sub> c	disable time	HD to Yn or Bn; see <u>Figure 6</u> and <u>8</u>	[3] _	-	20	ns
		HD to PLHO; see Figure 6 and $7$	[3] _	-	20	ns
		$R_L = 250 \Omega$ ; see Figure 6 and 7	[3]			
		DIR to Bn; TP load on B/Y side	-	-	50	ns
		DIR to An	-	-	15	ns
		OEA to An	-	-	6	ns
t <sub>en</sub>	enable time	HD to Yn or Bn; see <u>Figure 6</u> and <u>7</u>	[4] _	-	20	ns
		HD to PLHO; see Figure 6 and $7$	[4] _	-	20	ns
		$R_L = 250 \Omega$ ; see Figure 6 and 7	[4]			
		DIR to Bn; TP load on B/Y side	-	-	30	ns
		DIR to An	-	-	50	ns
		OEA to An	-	-	12	ns
$\Delta t_{PD}$	propagation delay difference	$t_{PZH} - t_{PHZ}$ ; HD to output	-	-	10	ns

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[2] Value at  $T_{amb}$  = 25  $^\circ C$  and  $V_{CC}$  = 3.3 V.

[3]  $t_{dis}$  is the same as  $t_{PHZ}$  and  $t_{PLZ}$ .

[4]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .

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### 11. Waveforms





#### Table 8. Slew rate measurements

t <sub>r</sub>	t <sub>f</sub>	t <sub>w</sub>	RL	V <sub>O</sub> transition (see Figure 8)	
				Rising	Falling
3 ns	3 ns	150 ns < t <sub>W</sub> < 10 μs	62 Ω	from V_O = 0.4 V to V_O = 0.9 V	from $V_O = 2.4$ V to $V_O = 1.9$ V

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#### Fig 6. Enable and disable times



#### Table 9. Test data for test circuit measuring enable disable times Bn to An

Parameter	V <sub>cc</sub>	Input		Output			V <sub>EXT</sub>	
		VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
DIR to Bn, An;	< 2.7 V	V <sub>CC</sub>	1.5 V	1.5 V	$V_{OL}\pm0.3~V$	$V_{OH} - 0.3 V$	GND	2V <sub>CC</sub>
OEA to An	2.7 V to 3.6 V	2.7 V	1.5 V	1.5 V	$V_{OL}\pm0.3~V$	$V_{OH} - 0.3 \ V$	GND	$2V_{CC}$
HD to Yn or Bn;	< 2.7 V	$V_{CC}$	1.5 V	1.5 V	-	$V_{OH} - 0.3 \ V$	open	-
HD to PHLO	2.7 V to 3.6 V	2.7 V	1.5 V	1.5 V	-	V <sub>OH</sub> – 0.3 V	open	-

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### PDI1284P11

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#### 12. Package outline



#### Fig 10. Package outline SOT370-1 (SSOP48)

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Fig 11. Package outline SOT362-1 (TSSOP48)

#### 3.3 V parallel interface transceiver/buffer

### **13. Abbreviations**

Table 11.	Abbreviations
Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ECP	Extended Capability Port
EPP	Enhanced Parallel Port
ESD	ElectroStatic Discharge
HBM	Human Body Model
LSTTL	Low-power Schottky Transistor-Transistor Logic
MM	Machine Model
TTL	Transistor-Transistor Logic

### 14. Revision history

#### Table 12.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PDI1284P11_3	20080825	Product data sheet	-	PDI1284P11_2
Modifications:	guidelines of NX <ul> <li>Legal texts have</li> <li>Quick reference</li> <li>Table 7, t<sub>PHL</sub>: Ma</li> </ul>	s data sheet has been red P Semiconductors been adapted to the new table removed. ximum value of 20 ns rep iations list added.	company name where	
PDI1284P11_2	19990917	Product specification	-	PDI1284P11_1
PDI1284P11_1	19970915	Product specification	-	-

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#### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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